Department of Materials Science and Engineering University of Maryland, College Park, Maryland

1. ENMA 440 – Nano Plasma Processing of Materials

 <u>Credits and contact hours – 3 credits</u>. The University of Maryland follows the Maryland Higher Education Commission's policies on "contact hours;" specifically, one semester hour of credit will be awarded for a minimum of 15 hours, of 50 minutes each of actual class time, exclusive of registration, study days, and holidays.

Schedule: meets two 75 minute periods per week

3. Instructor's or course coordinator's name: Prof. Gottlieb Oehrlein

 <u>Text book, title, author and year</u>: Brian Chapman, Glow Discharge Processes: Sputtering and Plasma Etching, (J. Wiley, 1980), ISBN-10: 047107828X; M.A. Lieberman, and A.J. Lichtenberg, Principles of Plasma Discharges and Materials Processing. (John Wiley & Sons; 2nd Edition edition, 2005) ISBN-10: 0471720011

5. Specific course information

- a. <u>Brief description of the content of the course (catalog description:</u> Sustaining mechanisms of plasmas are covered, especially low-pressure electrical gas discharges, fundamental plasma physics, sheath formation, electric and magnetic field effects, plasma-surface interactions in chemically reactive systems, plasma diagnostic techniques and selected industrial applications of low pressure plasmas.
- b. <u>Pre-requisites or co-requisites</u>: Permission of the department.
- c. <u>Indicate whether a required, elective, or selected elective (as per Table 5-1)</u> <u>course in the program</u>: ENMA 440 is an elective course for Materials Science and Engineering majors.
- 6. <u>Specific goals for the course:</u>
 - a. <u>Specific outcomes of instruction</u>: Student will know how to produce micro- and nanostructures using plasmas based on metals, polymers, and semiconductors.

b. Explicitly indicate which of the student outcomes listed in Criterion 3 or any other outcomes are addressed in this course.

ABET A: Ability to apply mathematics, science and engineering principles to design ABET G: Ability to communicate effectively

ABET I: Recognition of the need for and an ability to engage in life-long learning. ABET J: Knowledge of contemporary issues.

ABET K: Ability to use the techniques, skills and modern engineering tools necessary for engineering practice.

7. Brief list of topics to be covered:

- 1. Introduction
- 2. Plasma Physics
- 3. Plasma Production and Substrate Biasing
- 4. Plasma Chemistry: Gas Phase and Surface Processes
- 5. Plasma Measurements (Diagnostics)
- 6. Basic Patterning: Approaches to Produce Micro- and Nanostructures
- 7. Plasma-Based Patterning of Conductors and Insulators
- 8. Plasma-Assisted and Directional Materials Synthesis; Nanofibers and Nanorods
- 9. Special Methods for Nanostructures and Nanomaterials
- 10. Charge-Free, Neutral Beam and Atomic Layer Processing
- 11. Energy Problem & Applications
- 12. Emerging Applications and Outlook